

Belle II SVD operation, performance and upgrade activities

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On behalf of TIFR-Belle II group



May 5, 2022
@ DHEP annual review 2022



Outline of the talk

- ❑ SuperKEKB and Belle II
- ❑ Silicon-strip vertex detector (SVD) highlights
- ❑ Operational experience
- ❑ Performance
- ❑ Upgrade activities
- ❑ Summary and outlook

SuperKEKB and Belle II

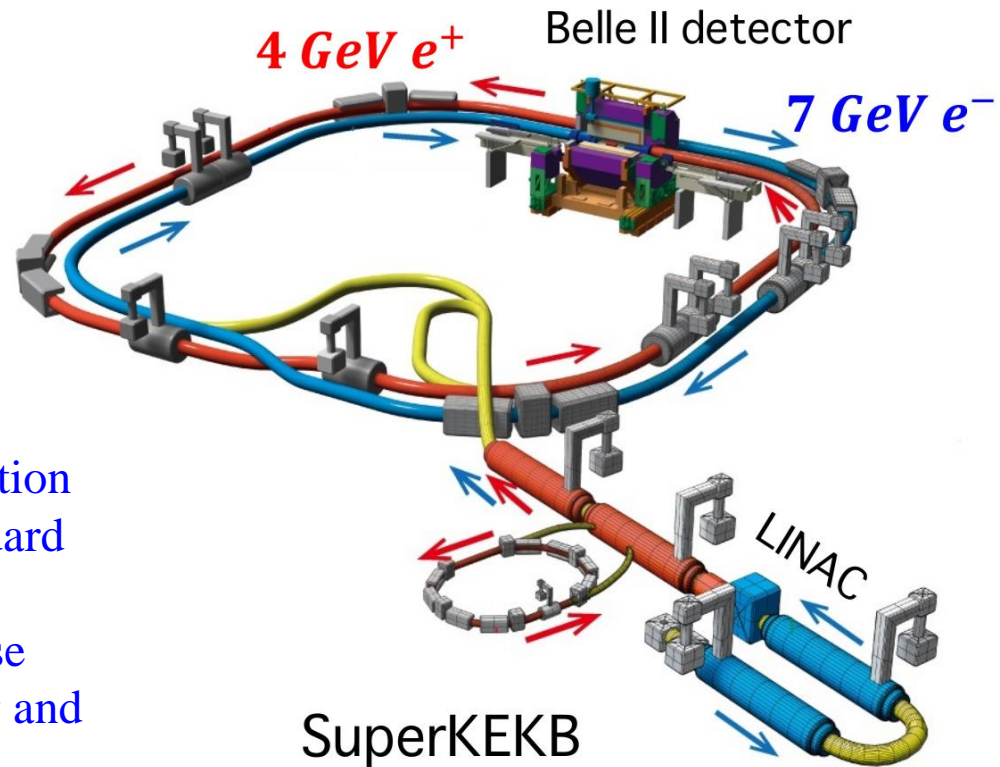
❑ Second-generation flavor factory

- Asymmetric e^+e^- collisions at $\Upsilon(4S)$ resonance $\Rightarrow 10.58 \text{ GeV}$
- Target \mathcal{L}_{int} : 50 ab^{-1} and $\mathcal{L}_{\text{peak}}$: $60 \times 10^{35} \text{ cm}^{-2} \text{ s}^{-1}$ ($30 \times \text{KEKB}$)
- Current record: $3.8 \times 10^{35} \text{ cm}^{-2} \text{ s}^{-1}$

❑ Belle II Detector

- Search for new sources of CP violation and probe physics beyond the standard model at the intensity frontier
- Physics requirements call for precise vertexing, low-momentum tracking and particle identification (PID)

❑ Vertex Detector is a key component in this pursuit



The Vertex Detector

Physics requirements:

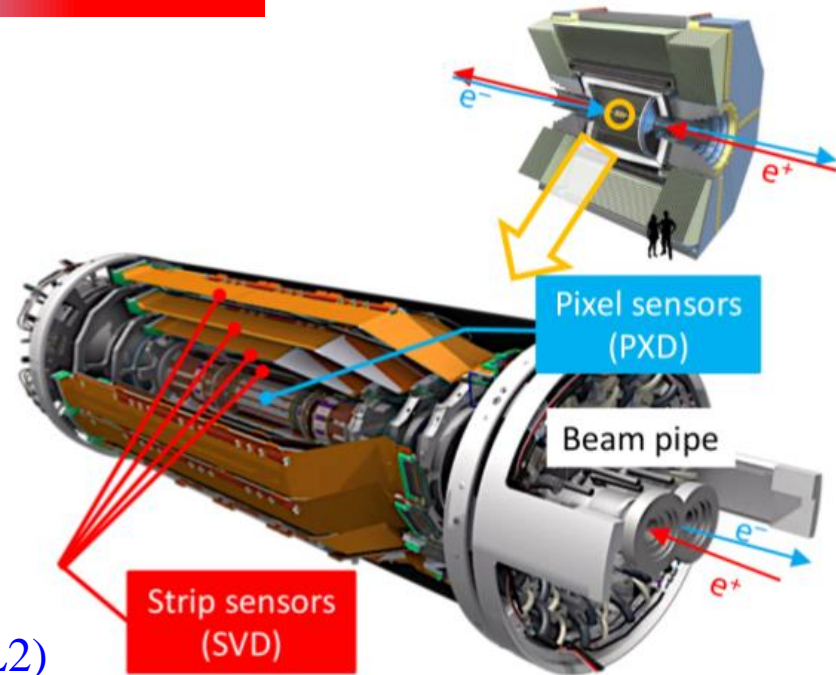
- Better vertexing resolution than Belle to compensate reduced boost \Rightarrow improved resolution, and lower material budget (0.7% X_0 per layer)
- Able to operate in high beam background \Rightarrow hit rate: 3 MHz/cm² @ SVD layer-3
- Radiation hard \Rightarrow 0.2 Mrad/yr @ SVD layer-3

Pixel Detector (PXD)

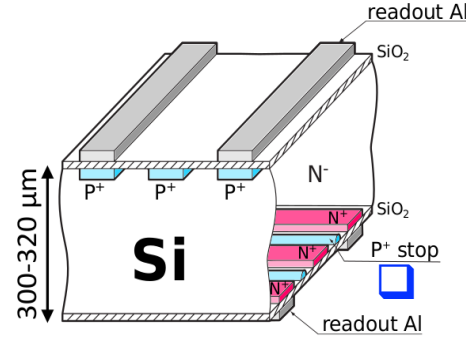
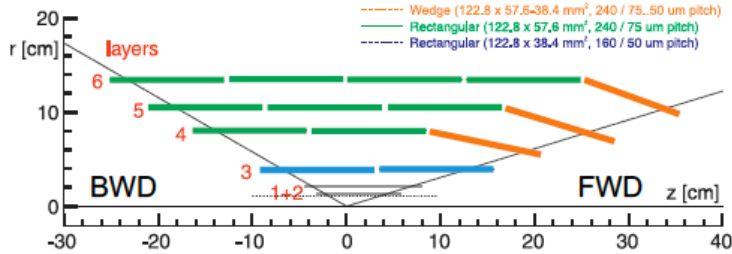
- DEPFET pixel sensors: Layer 1-2 (partial L2)

Silicon-strip Vertex Detector (SVD)

- Double-sided Si strip sensors: Layer 3-6
- Standalone tracking and PID for low p_T charged particles
- Extrapolate tracks to PXD (Region of interest)

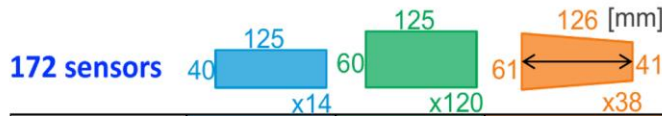


SVD in one slide



Origami 'chip-on-sensor' concept \Rightarrow small capacitive noise

AC coupled strips
 $V_{dep}: 2-60 \text{ V}$
 $V_{op}: 100 \text{ V}$

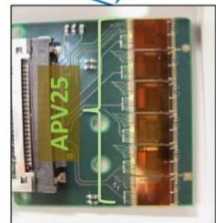
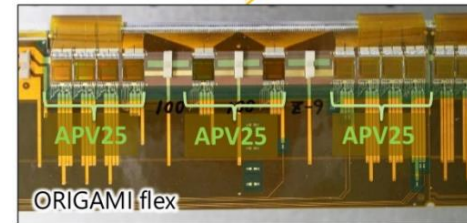
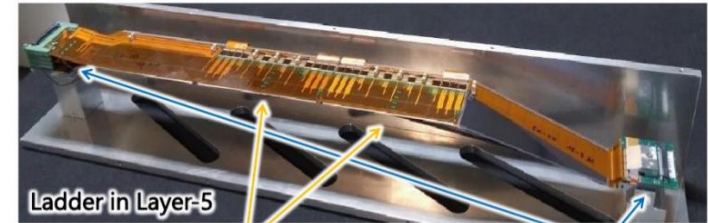


	Small	Large	Trapezoidal
# of p-strips*	768	768	768
p-strip pitch*	50 μm	75 μm	50-75 μm
# of n-strips*	768	512	512
n-strip pitch*	160 μm	240 μm	240 μm
thickness	320 μm	320 μm	300 μm
manufacturer	HPK		Micron

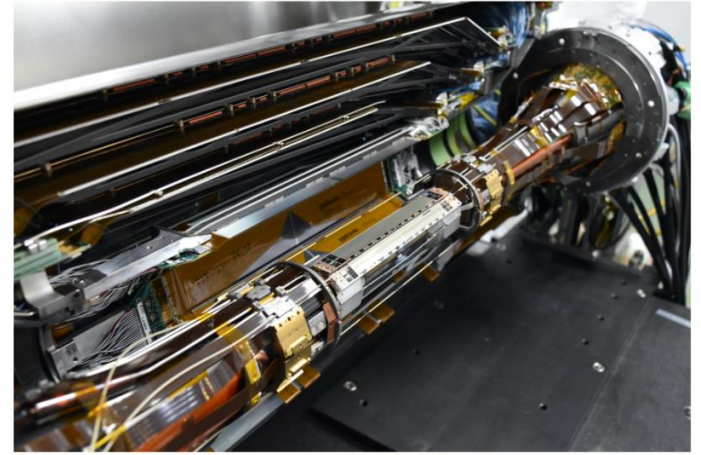
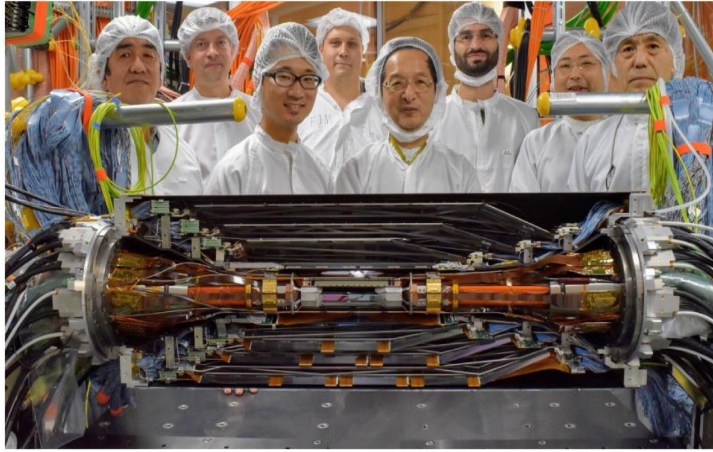
*readout strips – one floating strip on both sides

Layer	Ladder	Institute
3	7(+1)	Melbourne
4	10(+2)	TIFR Mumbai
5	12(+3)	HEPHY Vienna
6	16(+4)	Kavli IPMU

INFN Pisa: Layer 4-6 forward (FWD) and backward (BWD) modules

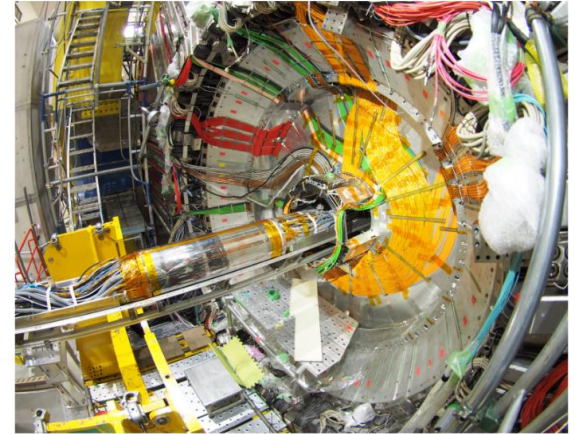


Various milestones

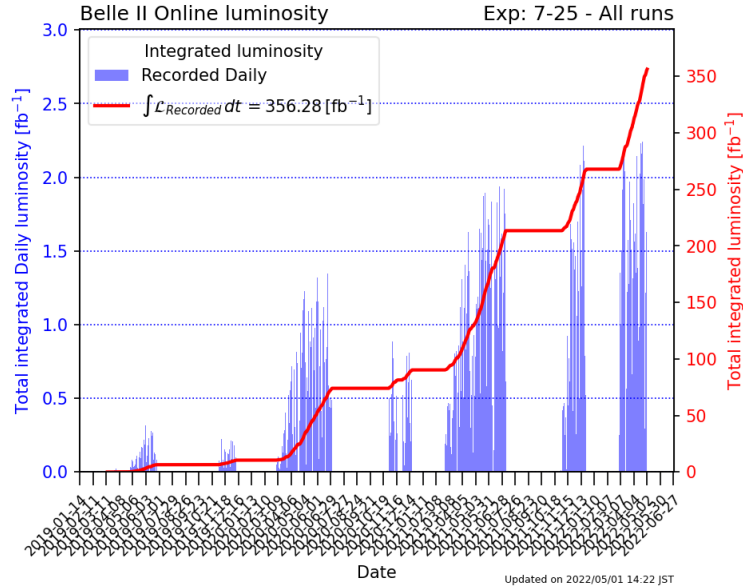


- ❑ 09-2008: Origami concept established
- ❑ 05-2015: First completed SVD ladder
- ❑ 02/07-2018: 1st/2nd “half shell” assembled
- ❑ 11-2018: Installed to Belle II
- ❑ 03-2019: 1st collision data with full VXD
- ❑ 01-2022: SVD paper submitted to JINST

[arXiv:2201.09824](https://arxiv.org/abs/2201.09824)



Operational experience in brief

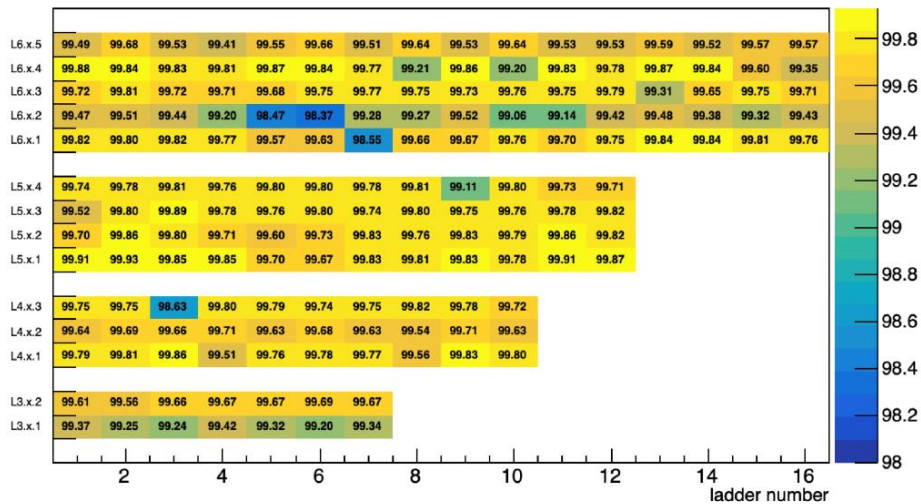


- ❑ Reliable and smooth operation since Mar 2019
- ❑ Excellent detector performance
- ❑ Hit efficiency $> 99\%$ in most sensors
- ❑ Reasonable cluster charge distribution
- ❑ Very good SNR in the range 13-30
- ❑ Improved simulation better agrees with the collision data

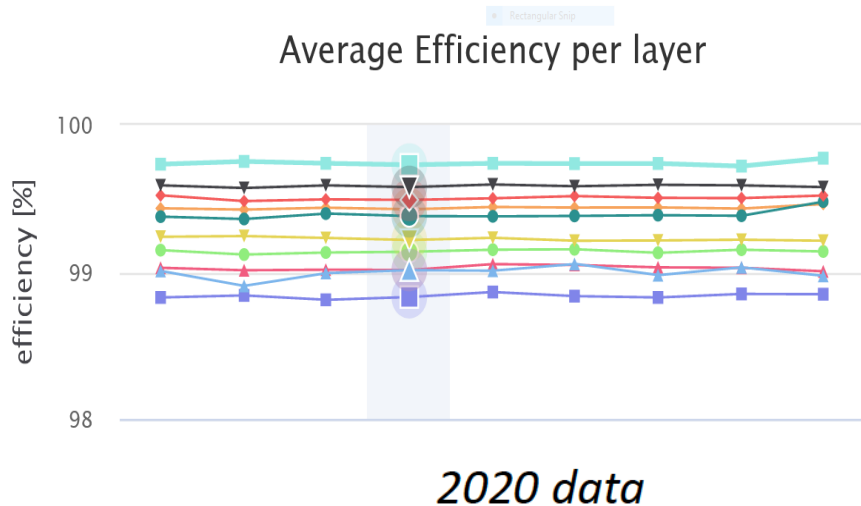
- ❑ Despite the covid 19 pandemic, Belle II continues to take data.
- ❑ Our group has been very active in taking remote operation and performance monitoring shift (22% of the total load)

Hit efficiency

N Efficiency Summary (in %)



Average Efficiency per layer



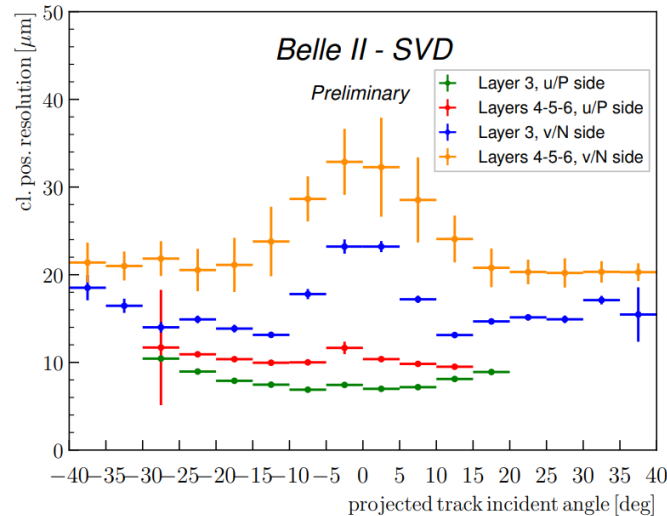
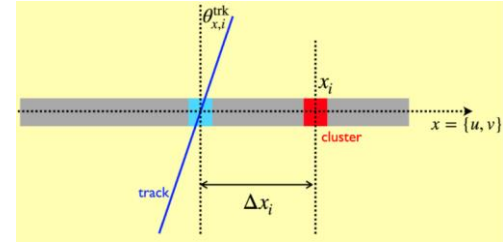
2020 data

layer	$\varepsilon(u/P)(\%)$	$\varepsilon(v/N)(\%)$
3	99.83 ± 0.01	99.48 ± 0.03
4	99.69 ± 0.03	99.68 ± 0.03
5	99.66 ± 0.03	99.77 ± 0.04
6	99.31 ± 0.08	99.58 ± 0.06

- Efficiency very high and stable in time
- > 99% for majority of sensors

Cluster position resolution

- ❑ Measured in $e^+e^- \rightarrow \mu^+\mu^-$ data
- ❑ Estimated from the residual of cluster position with respect to the track
- ❑ Position resolution in agreement with expectations from strip pitch
- ❑ Work continues to further improvement, especially in the u/P side



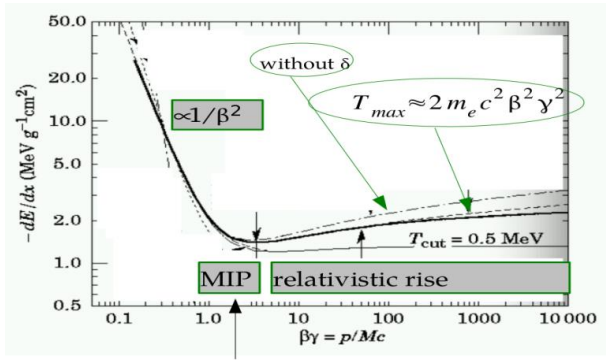
PID using SVD

Low p_T charged particles are mostly unable to reach CDC

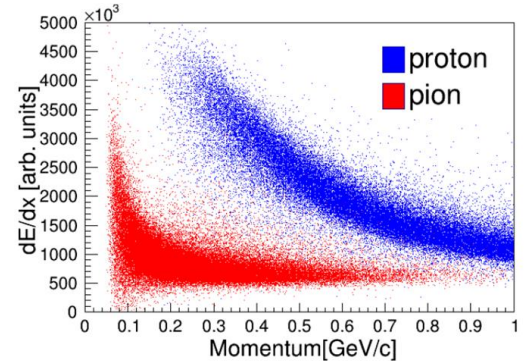
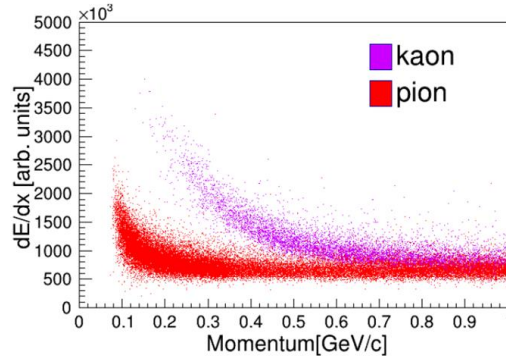


Exploit the specific ionization (dE/dx) information of SVD to identify various charged particles, especially pions vs. kaons

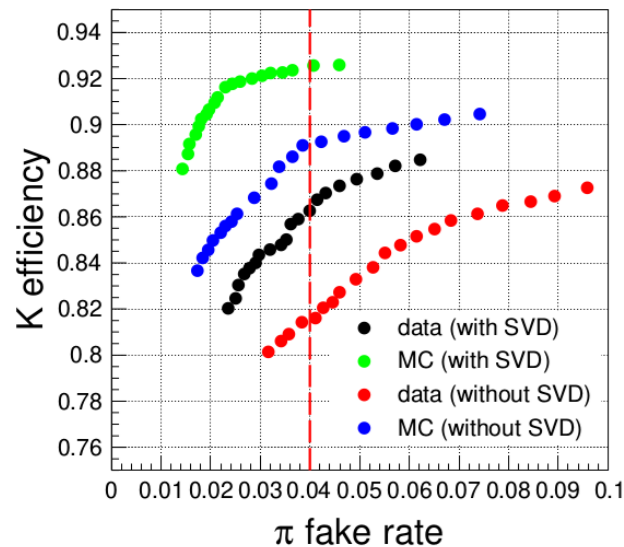
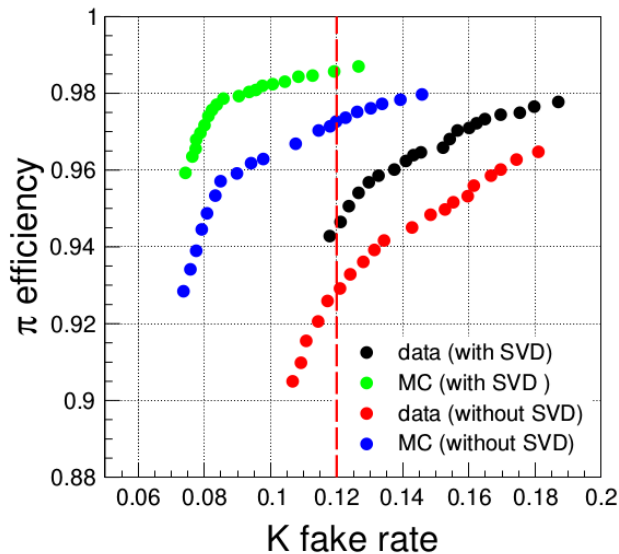
Use control samples of kinematically identified $D^{*+} \rightarrow D^0(K^-\pi^+)\pi_S^+$ and $\Lambda \rightarrow p\pi^-$ decays



$\beta\gamma \approx 3-4$



PID performance



Kaon efficiency vs. pion fake rate with and without SVD with $p < 1$ GeV

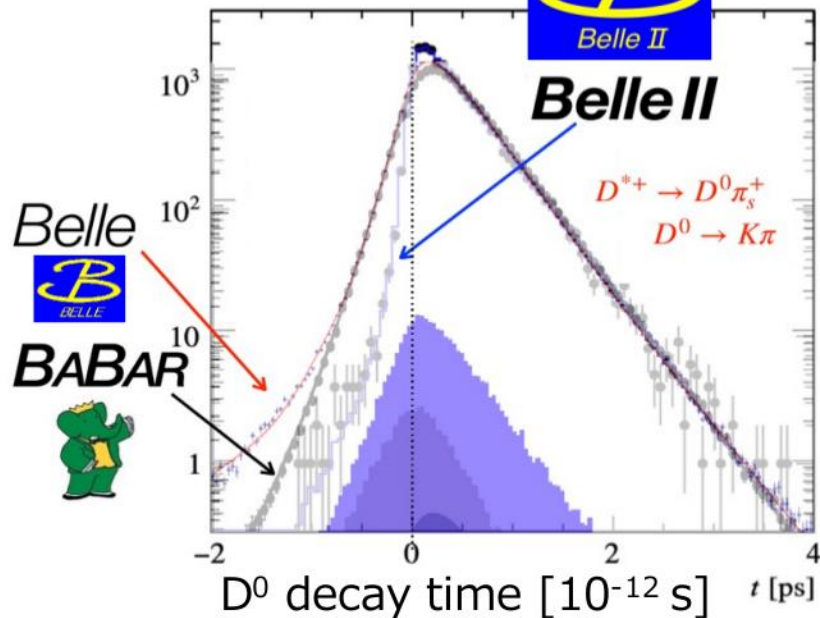
- Addition of SVD dE/dx information leads to significant improvement in the PID performance
- Data-MC difference arises mostly due to a suboptimal simulation of the cluster energy \Rightarrow work in progress

Physics performance



Excellent vertex resolution!

- ❑ Measured impact parameter resolut of $14.1 \pm 0.1 \mu\text{m}$
- **D lifetime measurement**
- ❑ Vertex determination plays a key role in this measurement
- ❑ Belle II time resolution is better than Belle by factor about two
- ❑ **World's most precise D lifetime measurements!**



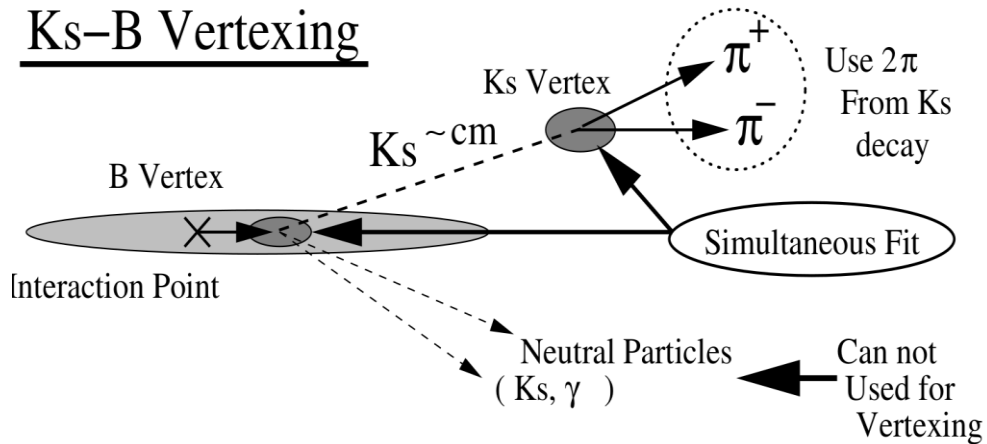
$$\tau(D^0) = 410.5 \pm 1.1 (\text{stat}) \pm 0.8 (\text{syst}) \text{ fs}$$
$$\tau(D^+) = 1030.4 \pm 4.7 (\text{stat}) \pm 3.1 (\text{syst}) \text{ fs}$$

Phys Rev Lett 127, 211801 (2021)

Something closer to my heart

- Perform a time-dependent study to measure the branching fraction and direct CP asymmetry for $B^0 \rightarrow K_S^0 \Pi^0$ decays.

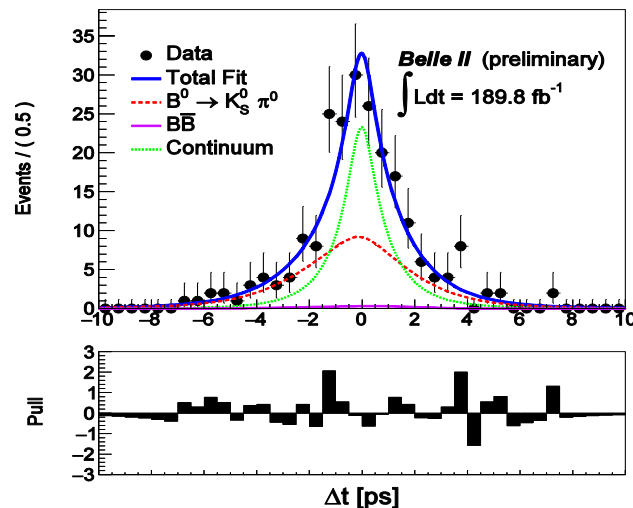
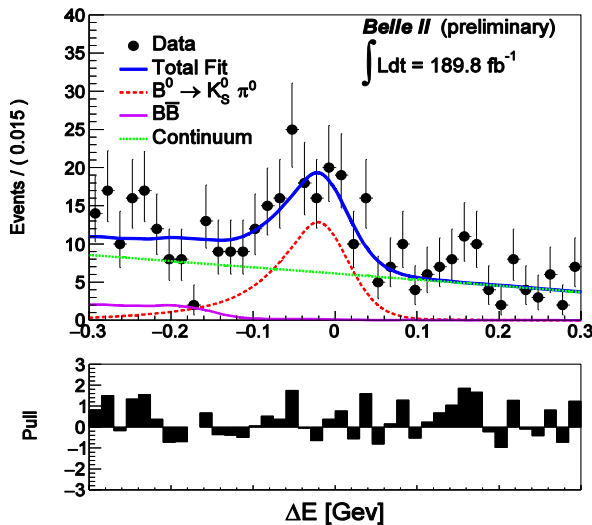
Challenge: No primary charge tracks to acilitate B^0



- B^0 vertex position is determined by projecting the K_S^0 trajectory to the interaction region.
- Excellent/ precise K_S^0 vertexing in SVD.

Results on \mathcal{B} and \mathcal{A}_{CP} for $B^0 \rightarrow K_S^0 \pi^0$

- 4D fit comprising M_{bc} , ΔE , continuum suppression output and Δt
- Use $B^0 \Rightarrow J/\psi (\mu^+ \mu^-) K_S^0$ to calibrate the signal Δt shape



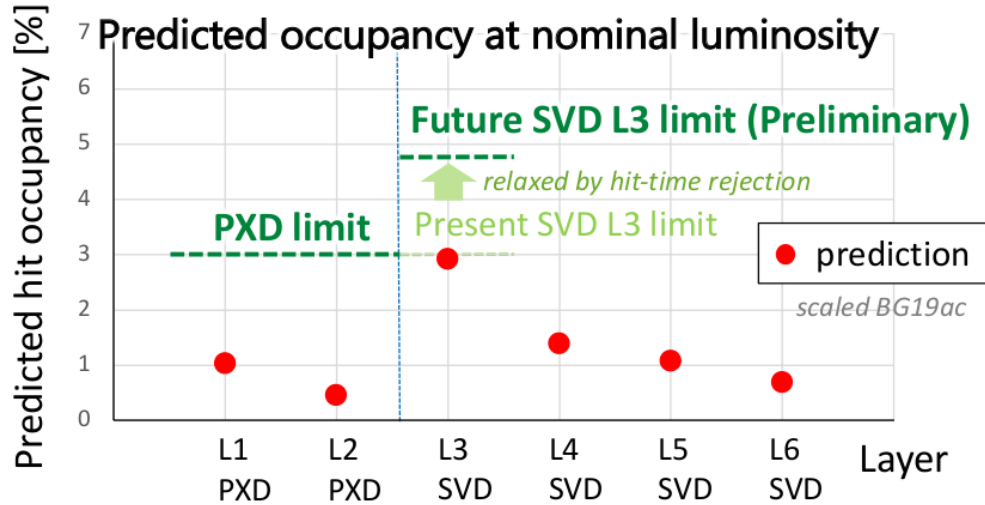
$$\mathcal{A}_{CP} = -0.41_{-0.32}^{+0.30}(\text{stat}) \pm 0.09(\text{syst})$$

$$\mathcal{B} = [11.0 \pm 1.2(\text{stat}) \pm 1.0(\text{syst})] \times 10^{-6}$$

Presented at Moriond 2022 conference

Limits on current VXD and upgrade

Tolerance for beam-induced background (BG)



Room to improve vertex resolution with better hit position resolution

➤ **Belle II VXD upgrade project formed**
Several technology options under investigation by R & D subgroups

- Thin fine pitch sensor
- Upgraded DEPFET sensor
- SOI pixel sensor
- CMOS pixel sensor

- Predicted BG within limits, BUT without enough safety margin

TIFR is a part of SVD-TFP upgrade project.

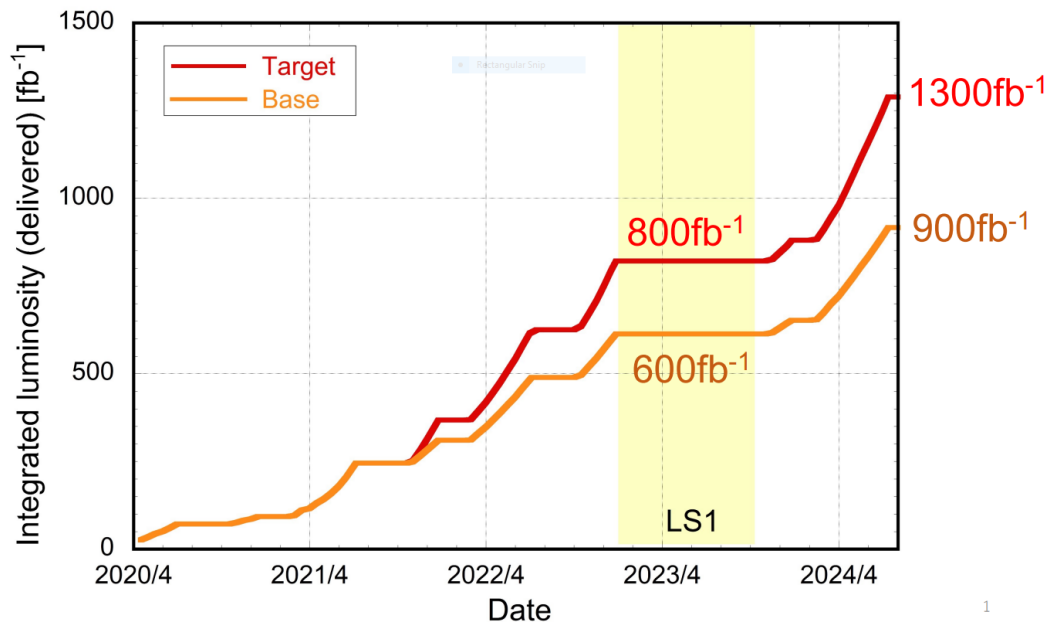
Time scale of the VXD upgrade project

➤ Occasion of new VXD installation:

Timeframe expected to 2026-27
but still with uncertainty

➤ R& D activities will access the options

- Which concept bring best performance?
- Which technologies fit the requirements?
- Which technology fit timeframe of installation?



- ❑ Development of a test-bench for silicon strip detector present in Rahul's poster.

Summary and outlook

- ❑ SVD has been successfully recording data since Mar 2019 \Rightarrow smooth and reliable operation
- ❑ Our group is a key player in the remote operation and monitoring of SVD.
- ❑ Very good and stable performance \Rightarrow there is still room for improvement, especially in tuning of simulation
- ❑ Addition of SVD dE/dx information improves the particle identification in the low momentum region.
- ❑ Upgrade of Belle II VXD is desirable.

Thank you